

**ORGANIC ELECTRONIC PACKAGES HAVING
HERMETICALLY SEALED EDGES AND METHODS OF
MANUFACTURING SUCH PACKAGES**

ABSTRACT

[0045] Organic electronic packages having sealed edges. More specifically, packages having organic electronic devices are provided. A number of sealing mechanisms are provided to hermetically seal the edges of the package to completely protect the organic electronic device from external elements. A sealant may be implemented to completely surround the organic electronic device. Alternatively, edge wraps may be provided to completely surround the organic electronic device.